MSKSEMI















ESD

TVS

TSS

MOV

GDT

PLED

Broduct data sheet





Features

Ideal for printed circuit board

Reliable low cost construction utilizing molded plastic technique

High temperature soldering guaranteed: 260°/ 10 seconds at 5 $\,$

lbs., (2.3kg) tension

Small size, simple installation

High surge current capability

.047(1.20) .047(1.20) .035(0.9) .014(0.35) .014(0.35) .014(0.35) .014(0.35) .014(0.35) .014(0.35) .014(0.35)

Mechanical Data

Case: JEDEC DBS Molded plastic body

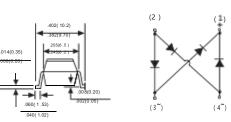
Terminals: Solder plated, solderable per MIL- STD- 750, Method

2026

Polarity: Polarity symbol marking on case

Mounting Position : Any

Weight: 0 .02 ounce, 0 .4 grams



Dimensions in inches and (millimeters)

REEL SPECIFICATION

P/N	PKG	QTY
DF005S-DF10S	DBS	1500

Maximum Ratings And Electrical Characteristics

Ratings at 25 °C ambient temperature unless otherwisespecified.

Single phase half-wave 60 Hz, resistive or inductive load, for capacitive load current derate by 20%.

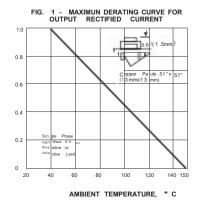
Parameter	OVAIDOL O		DF01S	DF02S	DF04S	DF06S	DF08S	DF10S	UNITS
Marking Code	SYMBOL S	DF005S							
Maximum repetitive peak reverse voltage	VRRM	50	100	200	400	600	800	1000	V
Maximum RMS voltage	VRMS	35	70	140	280	420	560	700	V
Maximum DC blocking voltage	VDC	50	100	200	400	600	800	1000	V
Maximum average forward rectified current at Tc=40°C	I _{F(AV)} 1.0					А			
Peak forward surge current, 8.3ms single half sine-wave superimposed on rated load (JEDEC Method)	Irsm 50				А				
Maximum instantaneous forward voltage drop per leg at 1A	VF				1.1				V
Maximum DC reverse current T _A =25°C at rated DC blocking voltage T _A =100°C	lR	10 500					μA μA		
Operating temperature range	Тл	-55 to + 150				°C			
storage temperature range	Тѕтс	-55 to + 150				°C			

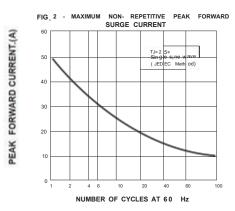
NOTES:DBS for surface mount package.



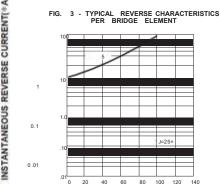




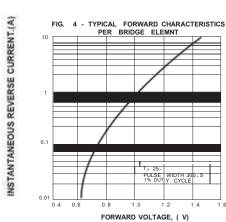


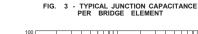


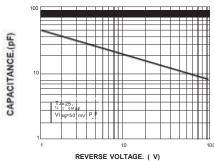
INSTANTANEOUS REVERSE CURRENT(*A)



PERCENT OF RATED PEAK REVERSE VOLTAGE . (%)







The curve above is for reference only.





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